

**PATENT**

Attorney Docket No.: 5432/55399

**DECLARATION, POWER OF ATTORNEY AND CORRESPONDENCE ADDRESS**

We, David Paul Boden and Benjamin Paul Labovitz, the below named joint inventors, hereby declare that:

Our residences, post office addresses and citizenships are as stated below next to our respective names.

We believe we are the original, first and joint inventors of the subject matter which is claimed and for which a patent is sought on the invention entitled "BATTERY PASTE ADDITIVE AND METHOD FOR PRODUCING BATTERY PLATES", the specification of which is attached hereto.

We hereby state that we do not know and do not believe that this invention was ever known or used in the United States of America before our invention thereof or patented or described in any printed publication in any country before our invention thereof or more than one year prior to this application, or in public use or on sale in the United States of America for more than one year prior to this application; that this invention has not been patented or made the subject of an inventor's certificate issued before the date of this application in any country foreign to the United States of America on an application filed by us by our legal representatives or assigns more than six months prior to this application; that we acknowledge a duty to disclose information that we are aware of which is material to the examination of this application; that no application for patent or inventor's certificate on this invention has been filed by us or our legal representatives or assigns in any country foreign to the United States of America; and that no foreign filing has been made which is contrary to 35 U.S.C. Section 184.

We hereby state that we have reviewed and understand the contents of the above identified specification, including the claims as amended by any amendment thereto.

We acknowledge the duty to disclose information which is material to the examination of this application in accordance with title 37, Code of Federal Regulations, Section 1.56(a).

We hereby claim the benefit under Title 35, United States Code, Section 120 of any United States applications listed below and, insofar as the subject matter of each of the claims of this

application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing of this application:

None

None

None

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Application Serial No.

Filing Date

Status


We hereby declare that all statements made hereby of our own knowledge are true and that all statements made on information and belief are believed to be true; that any willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

And we hereby appoint: Timothy T. Patula, Reg. No. 30,791 and Charles T. Riggs, Jr., Reg. No. 37,430 of the firm of Patula and Associates, P.C., as our attorneys, with full power of substitution and revocation, to prosecute this application, to make alterations and amendments therein, to receive the patent and to transact all business in the Patent and Trademark Office connected therewith.

We request that all correspondence be directed to:

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David Paul Boden  
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Signature

March 17, 2004  
Date

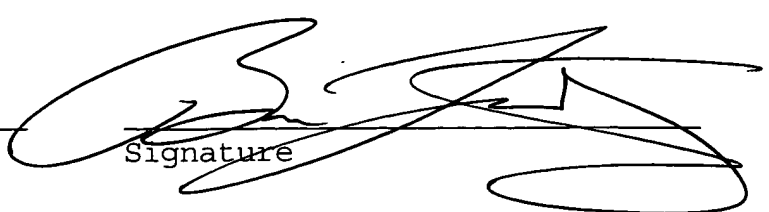
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